

Declaration For Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled _____

STRUCTURE OF THE STEM OF LED CHIP UNIT BULB

the specification of which

(check one) ☒ is attached hereto.

☐ was files on _____ as

Application Serial No. _____

and was amended on _____

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified speciation, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 122, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status) (patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status) (patented, pending, abandoned)

And I hereby appoint as principal attorneys

Please direct all communications to the following address:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Lee, Han-Ming

Inventor's signature

LEE Han ming

Date

JUN 06 2003

Residence

HSIN CHU CITY, TAIWAN

Citizenship

TAIWAN

Post Office Address

P. O. BOX 7-288, TAIPEI 106, TAIWAN

Full name of sole or Second inventor if any

Inventor's signature

Date

Residence

Citizenship

Post Office Address

(Supply similar information and signature for third and subsequent joint inventors.)

Independent Inventor

Attorney's
Docket No. _____

VERIFIED STATEMENT OF SMALL ENTITY STATUS

Honorable Commissioner of patent and Trademarks
Washington, D. C. 20231

Sir:

I hereby declare that I am ☒ the sole inventor ☐ a joint inventor of the invention
entitled: STRUCTURE OF THE STEM OF LED CHIP UNIT BULB

the invention being described and claimed ☒ in the specification filed herewith, ☐ in the
specification of application Serial No. _____, filed _____ 20____;
and that I have not assigned, granted, conveyed, or licensed , and that I am under no obligation
under contract or law to assign, grant, convey or license, any rights in the invention to any person
who could not likewise be classified as an independent inventor if that person had made the
invention, or to any concern which would not qualify as a small business concern or a nonprofit
organization.

I further declare that all statements made herein of my own knowledge are true and
that all statements made on information and belief are believed to be true; and further that these
statements were made with the knowledge that willful false statements and the like so made are
punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States
Code, and that such willful false statements may jeopardize the validity of the application or any
patent issuing thereon.

Lee, Han-Ming

NAME OF INVENTOR

NAME OF INVENTOR

NAME OF INVENTOR

LEE Han ming

Signature of Inventor

Signature of Inventor

Signature of Inventor

JUN 06 2003

Date

Date

Date